Table 1. PIN DESCRIPTION

Pin #	Pin Name	Туре	Description
1	CLKIN	I	External reference Clock input.
2	FS	I	Frequency Select. Has an internal pull-down resistor. see Frequency Selection table
3	PD#	I	Power Down. Pull LOW to enable Power Down. Pull HIGH to disable power down. Output Clock will be LOW when power down is enabled. Has an internal pull-up resistor
4	GND	Р	Ground
5	ModOUT	0	Buffered modulated Timing-Safe clock output
6	MR	I	Modulation Rate Select. When LOW selects Low Modulation Rate. Selects High Modulation Rate when pulled HIGH. Has an internal pull-up resistor.
7	SSEXTR	I	Analog Frequency Deviation Selection through external resistor to GND.
8	VDD	Р	1.8 V Supply Voltage

Table 2. FREQUENCY SELECTION TABLE

FS	Frequency (MHz)		
0	15–30		
1	30–60		

Table 3. ABSOLUTE MAXIMUM RATING

Parameter	Min	Max	Unit
Supply Voltage to Ground Potential	-0.3	+2.7	V
DC Input Voltage(CLKIN)	-0.3	+2.7	V
DC Input Voltage (Except CLKIN)	-0.3	V _{DD} + 0.3	V
Storage Temperature	-65	+150	°C
Max. Soldering Temperature (10 sec)		260	°C
Junction Temperature		150	°C
Static Discharge Voltage (As per JEDEC STD22–A114–B)		2000	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 4. OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V_{DD}	Supply Voltage	1.6	2	V
T _A	Operating Temperature	-20	+85	°C
C _L	Load Capacitance		15	pF
C _{IN}	Input Capacitance		7	pF

Table 5. DC ELECTRICAL CHARACTERISTICS FOR V_{DD} = 1.8 V $\pm\,$ 0.2 V

Symbol	Parameter	Tes	Test Conditions		Тур	Max	Unit	
VDD	Supply Voltage				1.8	2	V	
V _{IH}	Input HIGH Voltage			0.65 * V _{DD}			V	
V _{IL}	Input LOW Voltage	Voltage				0.35 * V _{DD}	V	
I _{IH}	Input HIGH Current	,	V _{IN} = V _{DD}			5	μΑ	
I _{IL}	Input LOW Current		V _{IN} = 0 V			5	μΑ	
V _{OH}	Output HIGH Voltage	I _{OH} = -8	I _{OH} = -8 mA (P3PSL450A) I _{OH} = -16 mA (P3PSL450AH)				V	
		I _{OH} = -16						
V _{OL}	Output LOW Voltage	I _{OL} = 8 r	I _{OL} = 8 mA (P3PSL450A)			0.25 * V _{DD}	V	
		I _{OL} = 16 r	nA (P3PSL450AH)					
I _{CC}	Static Supply Current	CLKIN & PD	CLKIN & PD# pins pulled to GND			10	μΑ	
I _{DD}	Dynamic Supply Current	1 , 11 ,	Unloaded	FS = 0, @ 15 MHz		1.7	2.2	mA
		Output	FS = 0, @ 30 MHz		3.0	3.7		
			FS = 1, @ 30 MHz		2.6	3.7		
			FS = 1, @ 60 MHz		4.3	6.4		
Z _o	Output Impedance	P3PSL450A			23		Ω	
			P3PSL450AH		17			

Table 6. AC ELECTRICAL CHARACTERISTICS FOR V_{DD} = 1.8 V $\pm\,$ 0.2 V

Parameter	Test 0	Min	Тур	Max	Unit		
Input Frequency	FS = 0			15		30	MHz
	FS = 1			30		60	
ModOUT	F	15		30			
	F	30		60			
Duty Cycle (Notes 1 and 2)	Measur	ed at V _{DD} / 2		45	50	55	%
Rise Time	Measured between 20% to	P3PSL450A			1.3	2.1	ns
(Notes 1 and 2)	80%	P3PSL450AH			1	1.7	
Fall Time	Measured between 80% to	P3PSL450A			1.3	2.1	ns
(Notes 1 and 2)	20%	P3PSL450AH			1	1.7	
Cycle-to-Cycle Jitter	Unloaded output with SSEXTR pin OPEN	FS = 0	15 MHz		± 150	± 250	ps
(Note 2)			24 MHz		± 100	± 150	
			30 MHz		±80	± 150	
		FS = 1	30 MHz		± 150	±250	
			60 MHz		± 100	± 150	
PLL Lock Time ²	Stable power supply, valid PD# toggled	power supply, valid clock presented on CLKIN pin, PD# toggled from Low to High				1	ms

All parameters are specified with 15 pF loaded output.
 Parameter is guaranteed by design and characterization. Not 100% tested in production

SWITCHING WAVEFORMS

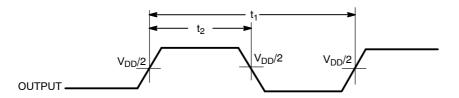


Figure 2. Duty Cycle Timing

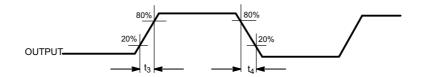
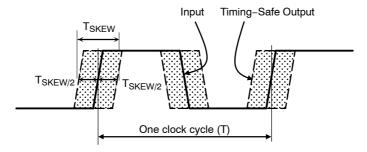
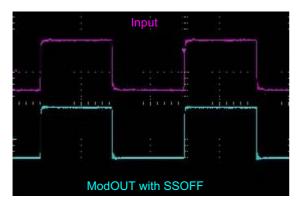


Figure 3. Output Rise/Fall Time



 T_{SKEW} represents input–output skew when spread spectrum is ON For example, $T_{SKEW/2} = \pm 0.20 * T$ for an Input clock of 24 MHz, translates in to (1/24 MHz) * 0.20 = 8.33 ns

Figure 4. Input-Output Skew



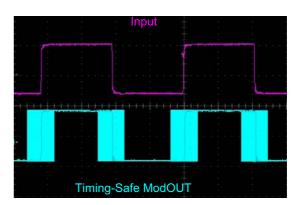
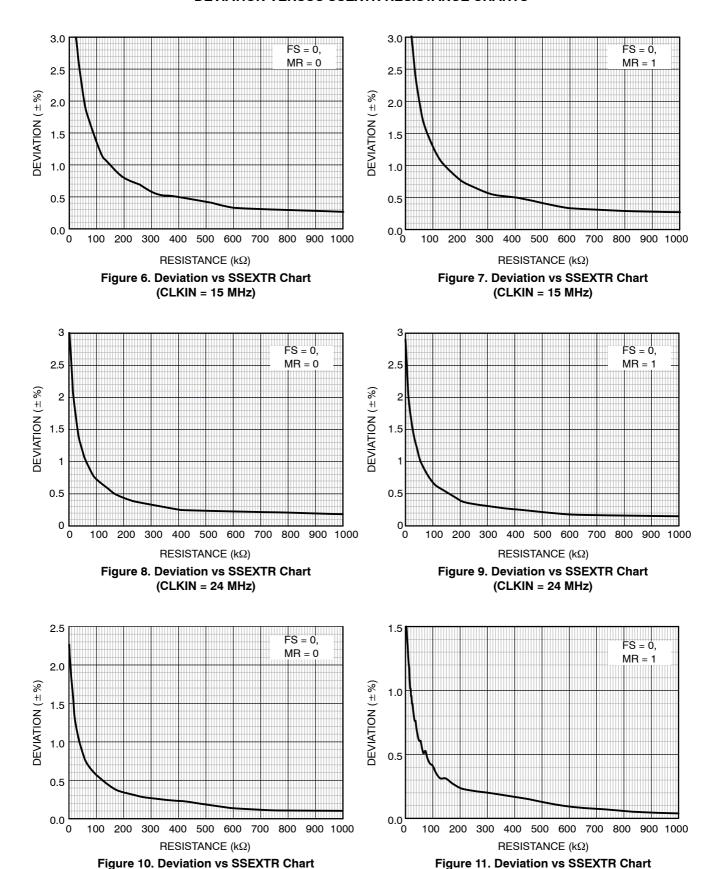


Figure 5. Typical Example of Timing-Safe Waveform

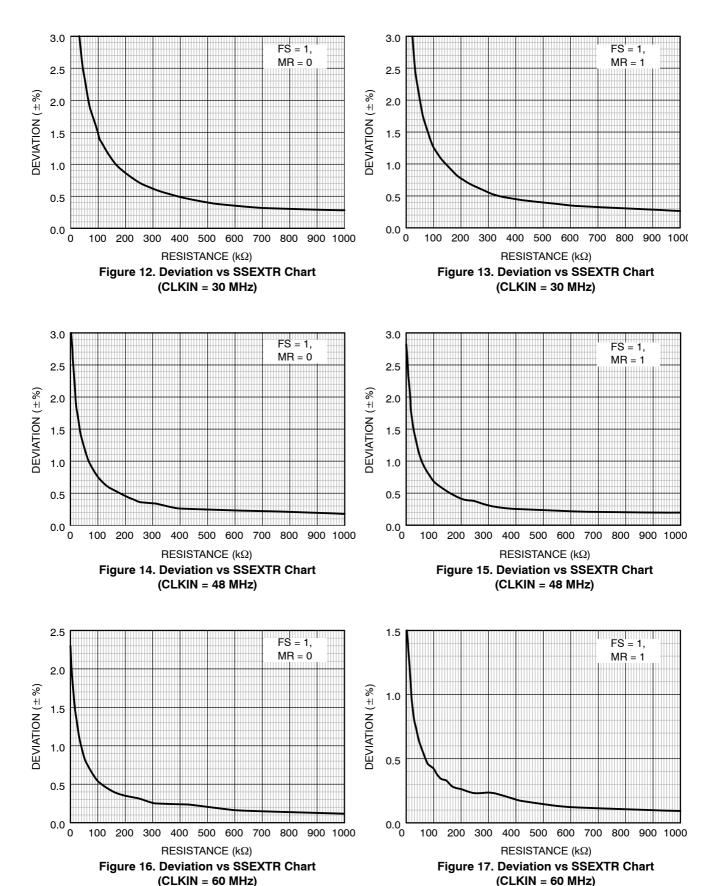
DEVIATION VERSUS SSEXTR RESISTANCE CHARTS

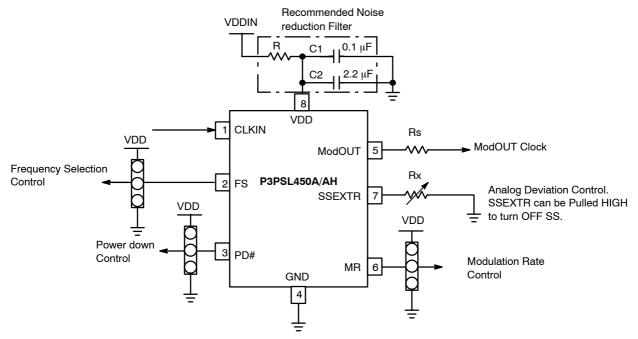


(CLKIN = 30 MHz)

(CLKIN = 30 MHz)

DEVIATION VERSUS SSEXTR RESISTANCE CHARTS





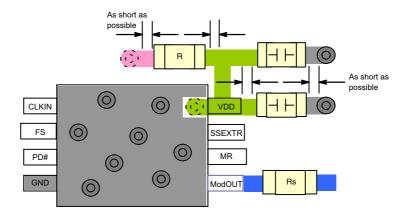
NOTE: Refer to Pin Description table for Functionality details

Figure 18. Typical Application Schematic

PCB LAYOUT RECOMMENDATION

For optimum device performance, following guidelines are recommended.

- Dedicated V_{DD} and GND planes.
- The device must be isolated from system power supply noise. A 0.1 μF and a 2.2 μF decoupling capacitor should be mounted on the component side of the board as close to the V_{DD} pin as possible. No vias should be used between the decoupling capacitor and V_{DD} pin. The PCB trace to V_{DD} pin and the ground via should be kept as short as possible. All the V_{DD} pins should have decoupling capacitors.
- In an optimum layout all components are on the same side of the board, minimizing vias through other signal layers. A typical layout is shown in the Figure below:



ORDERING INFORMATION

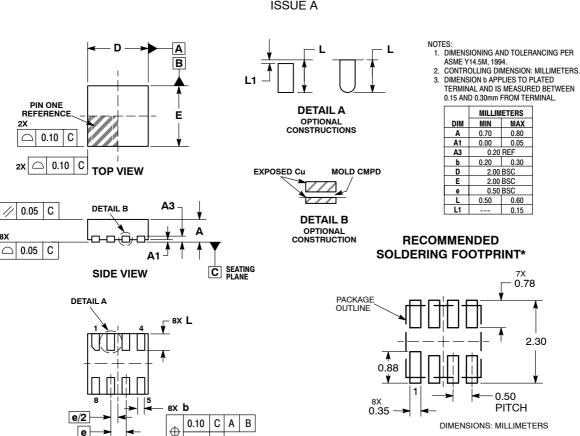
Ordering Code	Marking	Temperature	Package Type	Shipping [†]
P3PSL450AG-08CR	FA	−20°C to +85°C	8- pin (2 mm x 2 mm) WDFN (Pb-Free)	Tape & Reel
P3PSL450AHG-08CR	FC	−20°C to +85°C	8- pin (2 mm x 2 mm) WDFN (Pb-Free)	Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}A "microdot" placed at the end of last row of marking or just below the last row toward the center of package indicates Pb-Free.

PACKAGE DIMENSIONS

WDFN8 2x2, 0.5P CASE 511AQ-01 ISSUE A



С моте з

0.05

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Timing-Safe is a trademark of Semiconductor Components Industries, LLC (SCILLC).

BOTTOM VIEW

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA **Phone**: 303–675–2175 or 800–344–3860 Toll Free USA/Canada

Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center

Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative